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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	AVR
Core Size	8/16-Bit
Speed	32MHz
Connectivity	I²C, IrDA, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (64K x 16)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atxmega128a4u-aur

6. AVR CPU

6.1 Features

- 8/16-bit, high-performance Atmel AVR RISC CPU
  - 142 instructions
  - Hardware multiplier
- 32x8-bit registers directly connected to the ALU
- Stack in RAM
- Stack pointer accessible in I/O memory space
- Direct addressing of up to 16MB of program memory and 16MB of data memory
- True 16/24-bit access to 16/24-bit I/O registers
- Efficient support for 8-, 16-, and 32-bit arithmetic
- Configuration change protection of system-critical features

6.2 Overview

All Atmel AVR XMEGA devices use the 8/16-bit AVR CPU. The main function of the CPU is to execute the code and perform all calculations. The CPU is able to access memories, perform calculations, control peripherals, and execute the program in the flash memory. Interrupt handling is described in a separate section, refer to “Interrupts and Programmable Multilevel Interrupt Controller” on page 29.

6.3 Architectural Overview

In order to maximize performance and parallelism, the AVR CPU uses a Harvard architecture with separate memories and buses for program and data. Instructions in the program memory are executed with single-level pipelining. While one instruction is being executed, the next instruction is pre-fetched from the program memory. This enables instructions to be executed on every clock cycle. For details of all AVR instructions, refer to http://www.atmel.com/avr.

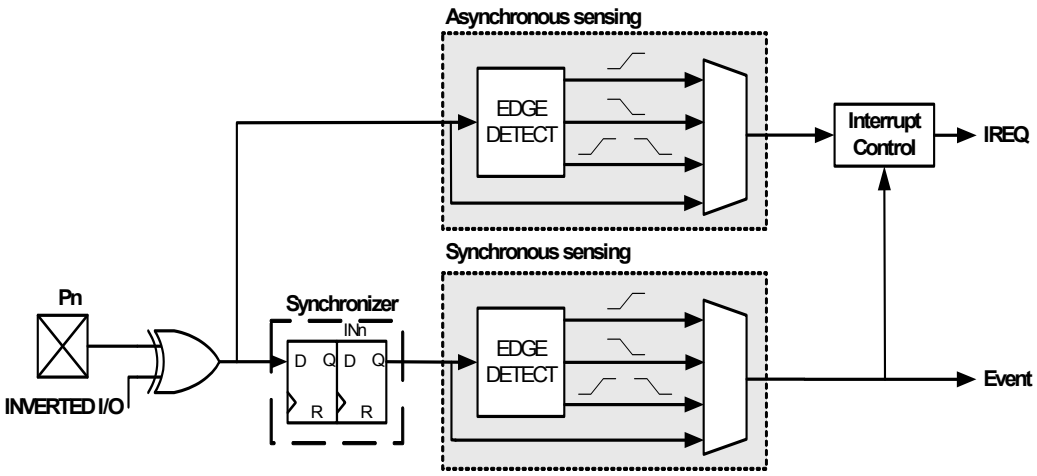
Table 14-1. Reset and interrupt vectors

Program address (base address)	Source	Interrupt description
0x000	RESET	
0x002	OSCF_INT_vect	Crystal oscillator failure interrupt vector (NMI)
0x004	PORTC_INT_base	Port C interrupt base
0x008	PORTR_INT_base	Port R interrupt base
0x00C	DMA_INT_base	DMA controller interrupt base
0x014	RTC_INT_base	Real time counter interrupt base
0x018	TWIC_INT_base	Two-Wire Interface on Port C interrupt base
0x01C	TCC0_INT_base	Timer/counter 0 on port C interrupt base
0x028	TCC1_INT_base	Timer/counter 1 on port C interrupt base
0x030	SPIC_INT_vect	SPI on port C interrupt vector
0x032	USARTC0_INT_base	USART 0 on port C interrupt base
0x038	USARTC1_INT_base	USART 1 on port C interrupt base
0x03E	AES_INT_vect	AES interrupt vector
0x040	NVM_INT_base	Nonvolatile Memory interrupt base
0x044	PORTB_INT_base	Port B interrupt base
0x056	PORTE_INT_base	Port E interrupt base
0x05A	TWIE_INT_base	Two-wire Interface on Port E interrupt base
0x05E	TCE0_INT_base	Timer/counter 0 on port E interrupt base
0x06A	TCE1_INT_base	Timer/counter 1 on port E interrupt base
0x074	USARTE0_INT_base	USART 0 on port E interrupt base
0x080	PORTD_INT_base	Port D interrupt base
0x084	PORTA_INT_base	Port A interrupt base
0x088	ACA_INT_base	Analog Comparator on Port A interrupt base
0x08E	ADCA_INT_base	Analog to Digital Converter on Port A interrupt base
0x09A	TCD0_INT_base	Timer/counter 0 on port D interrupt base
0x0A6	TCD1_INT_base	Timer/counter 1 on port D interrupt base
0x0AE	SPID_INT_vector	SPI on port D interrupt vector
0x0B0	USARTD0_INT_base	USART 0 on port D interrupt base
0x0B6	USARTD1_INT_base	USART 1 on port D interrupt base
0x0FA	USB_INT_base	USB on port D interrupt base

15.4 Input sensing

Input sensing is synchronous or asynchronous depending on the enabled clock for the ports, and the configuration is shown in Figure 15-7.

Figure 15-7. Input sensing system overview.



When a pin is configured with inverted I/O, the pin value is inverted before the input sensing.

15.5 Alternate Port Functions

Most port pins have alternate pin functions in addition to being a general purpose I/O pin. When an alternate function is enabled, it might override the normal port pin function or pin value. This happens when other peripherals that require pins are enabled or configured to use pins. If and how a peripheral will override and use pins is described in the section for that peripheral. “Pinout and Pin Functions” on page 55 shows which modules on peripherals that enable alternate functions on a pin, and which alternate functions that are available on a pin.

26. AES and DES Crypto Engine

26.1 Features

- Data Encryption Standard (DES) CPU instruction
- Advanced Encryption Standard (AES) crypto module
- DES Instruction
  - Encryption and decryption
  - DES supported
  - Encryption/decryption in 16 CPU clock cycles per 8-byte block
- AES crypto module
  - Encryption and decryption
  - Supports 128-bit keys
  - Supports XOR data load mode to the state memory
  - Encryption/decryption in 375 clock cycles per 16-byte block

26.2 Overview

The Advanced Encryption Standard (AES) and Data Encryption Standard (DES) are two commonly used standards for cryptography. These are supported through an AES peripheral module and a DES CPU instruction, and the communication interfaces and the CPU can use these for fast, encrypted communication and secure data storage.

DES is supported by an instruction in the AVR CPU. The 8-byte key and 8-byte data blocks must be loaded into the register file, and then the DES instruction must be executed 16 times to encrypt/decrypt the data block.

The AES crypto module encrypts and decrypts 128-bit data blocks with the use of a 128-bit key. The key and data must be loaded into the key and state memory in the module before encryption/decryption is started. It takes 375 peripheral clock cycles before the encryption/decryption is done. The encrypted/encrypted data can then be read out, and an optional interrupt can be generated. The AES crypto module also has DMA support with transfer triggers when encryption/decryption is done and optional auto-start of encryption/decryption when the state memory is fully loaded.

30. AC – Analog Comparator

30.1 Features

- Two Analog Comparators (ACs)
- Selectable propagation delay versus current consumption
- Selectable hysteresis
  - No
  - Small
  - Large
- Analog comparator output available on pin
- Flexible input selection
  - All pins on the port
  - Output from the DAC
  - Bandgap reference voltage
  - A 64-level programmable voltage scaler of the internal AV_{CC} voltage
- Interrupt and event generation on:
  - Rising edge
  - Falling edge
  - Toggle
- Window function interrupt and event generation on:
  - Signal above window
  - Signal inside window
  - Signal below window
- Constant current source with configurable output pin selection

30.2 Overview

The analog comparator (AC) compares the voltage levels on two inputs and gives a digital output based on this comparison. The analog comparator may be configured to generate interrupt requests and/or events upon several different combinations of input change.

Two important properties of the analog comparator's dynamic behavior are: hysteresis and propagation delay. Both of these parameters may be adjusted in order to achieve the optimal operation for each application.

The input selection includes analog port pins, several internal signals, and a 64-level programmable voltage scaler. The analog comparator output state can also be output on a pin for use by external devices.

A constant current source can be enabled and output on a selectable pin. This can be used to replace, for example, external resistors used to charge capacitors in capacitive touch sensing applications.

The analog comparators are always grouped in pairs on each port. These are called analog comparator 0 (AC0) and analog comparator 1 (AC1). They have identical behavior, but separate control registers. Used as pair, they can be set in window mode to compare a signal to a voltage range instead of a voltage level.

PORTA has one AC pair. Notation is ACA.

32.2 Alternate Pin Functions

The tables below show the primary/default function for each pin on a port in the first column, the pin number in the second column, and then all alternate pin functions in the remaining columns. The head row shows what peripheral that enable and use the alternate pin functions.

For better flexibility, some alternate functions also have selectable pin locations for their functions, this is noted under the first table where this apply.

Table 32-1. Port A - alternate functions.

PORT A	PIN #	INTERRUPT	ADCA POS/ GAINPOS	ADCA NEG	ADCA GAINNEG	ACA POS	ACA NEG	ACAOUT	REFA
GND	38								
AVCC	39								
PA0	40	SYNC	ADC0	ADC0		AC0	AC0		AREF
PA1	41	SYNC	ADC1	ADC1		AC1	AC1		
PA2	42	SYNC/ASYNC	ADC2	ADC2		AC2			
PA3	43	SYNC	ADC3	ADC3		AC3	AC3		
PA4	44	SYNC	ADC4		ADC4	AC4			
PA5	1	SYNC	ADC5		ADC5	AC5	AC5		
PA6	2	SYNC	ADC6		ADC6	AC6		AC1OUT	
PA7	3	SYNC	ADC7		ADC7		AC7	AC0OUT	

Table 32-2. Port B - alternate functions.

PORT B	PIN #	INTERRUPT	ADCA POS	DACB	REFB
PB0	4	SYNC	ADC8		AREF
PB1	5	SYNC	ADC9		
PB2	6	SYNC/ASYNC	ADC10	DAC0	
PB3	7	SYNC	ADC11	DAC1	

Base address	Name	Description
0x0620	PORTB	Port B
0x0640	PORTC	Port C
0x0660	PORTD	Port D
0x0680	PORTE	Port E
0x07E0	PORTR	Port R
0x0800	TCC0	Timer/Counter 0 on port C
0x0840	TCC1	Timer/Counter 1 on port C
0x0880	AWEXC	Advanced Waveform Extension on port C
0x0890	HIRESC	High Resolution Extension on port C
0x08A0	USARTC0	USART 0 on port C
0x08B0	USARTC1	USART 1 on port C
0x08C0	SPIC	Serial Peripheral Interface on port C
0x08F8	IRCOM	Infrared Communication Module
0x0900	TCD0	Timer/Counter 0 on port D
0x0940	TCD1	Timer/Counter 1 on port D
0x0990	HIRESD	High Resolution Extension on port D
0x09A0	USARTD0	USART 0 on port D
0x09B0	USARTD1	USART 1 on port D
0x09C0	SPID	Serial Peripheral Interface on port D
0x0A00	TCE0	Timer/Counter 0 on port E
0x0A80	AWEXE	Advanced Waveform Extensionon port E
0x0A90	HIRESE	High Resolution Extension on port E
0x0AA0	USARTE0	USART 0 on port E

Symbol	Parameter	Condition		Min.	Typ.	Max.	Units
R_Q	Negative impedance [1]	XOSCPWR=0, FRQRANGE=0	0.4MHz resonator, CL=100pF	2.4k			Ω
			1MHz crystal, CL=20pF	8.7k			
			2MHz crystal, CL=20pF	2.1k			
		XOSCPWR=0, FRQRANGE=1, CL=20pF	2MHz crystal	4.2k			
			8MHz crystal	250			
			9MHz crystal	195			
		XOSCPWR=0, FRQRANGE=2, CL=20pF	8MHz crystal	360			
			9MHz crystal	285			
			12MHz crystal	155			
		XOSCPWR=0, FRQRANGE=3, CL=20pF	9MHz crystal	365			
			12MHz crystal	200			
			16MHz crystal	105			
		XOSCPWR=1, FRQRANGE=0, CL=20pF	9MHz crystal	435			
			12MHz crystal	235			
			16MHz crystal	125			
		XOSCPWR=1, FRQRANGE=1, CL=20pF	9MHz crystal	495			
			12MHz crystal	270			
			16MHz crystal	145			
		XOSCPWR=1, FRQRANGE=2, CL=20pF	12MHz crystal	305			
			16MHz crystal	160			
		XOSCPWR=1, FRQRANGE=3, CL=20pF	12MHz crystal	380			
			16MHz crystal	205			
	ESR	SF = Safety factor				$\min(R_Q)/SF$	kΩ
C_{XTAL1}	Parasitic capacitance XTAL1 pin				5.4		pF
C_{XTAL2}	Parasitic capacitance XTAL2 pin				7.1		pF
C_{LOAD}	Parasitic capacitance load				3.07		pF

Note: 1. Numbers for negative impedance are not tested in production but guaranteed from design and characterization.

Figure 37-25. I/O pin output voltage vs. source current.

V_{CC} = 3.0V.

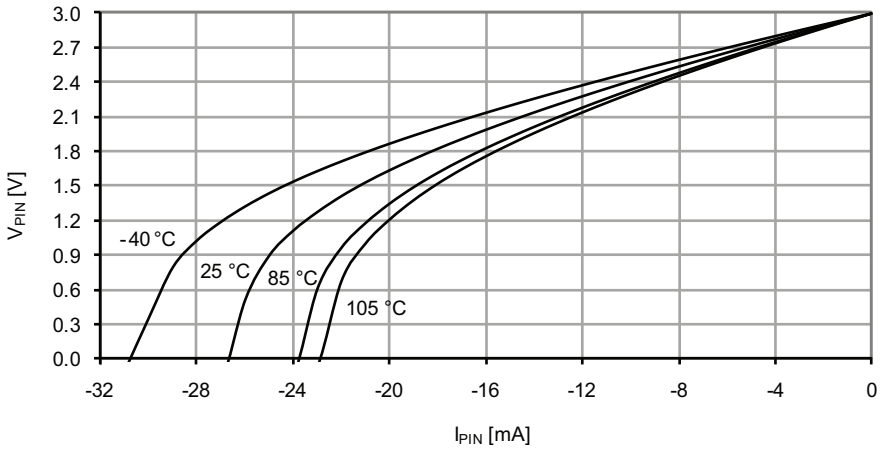


Figure 37-26. I/O pin output voltage vs. source current.

V_{CC} = 3.3V.

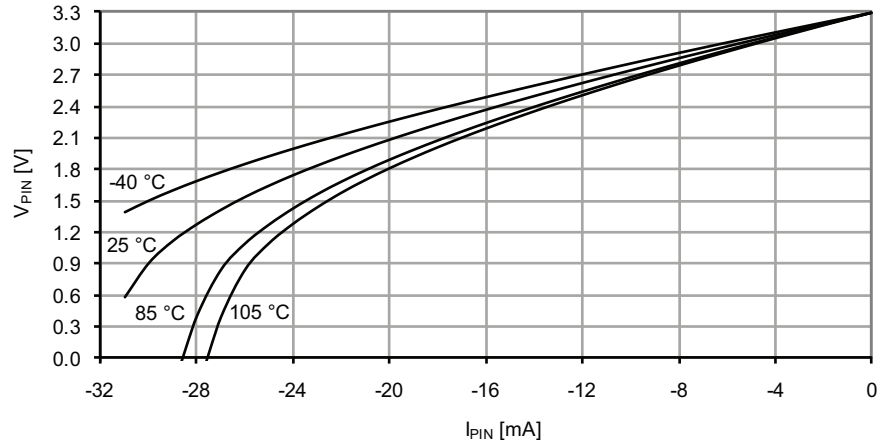


Figure 37-34. I/O pin input threshold voltage vs. V_{CC}.

V_{IL} I/O pin read as "0".

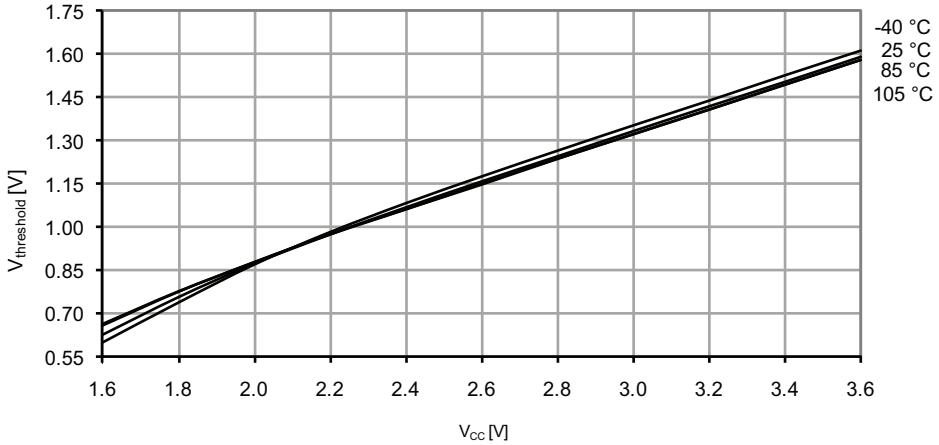
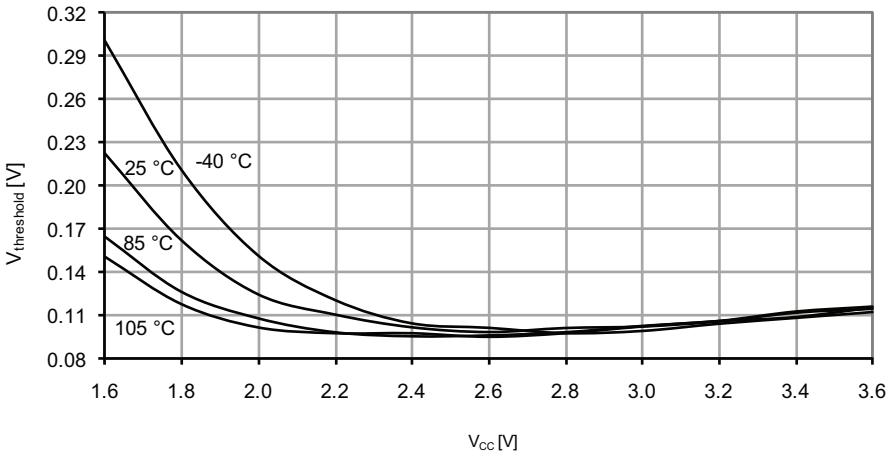


Figure 37-35. I/O pin input hysteresis vs. V_{CC}.



37.2 ATxmega32A4U

37.2.1 Current consumption

37.2.1.1 Active mode supply current

Figure 37-85.Active supply current vs. frequency.

f_{SYS} = 0 - 1MHz external clock, T = 25°C.

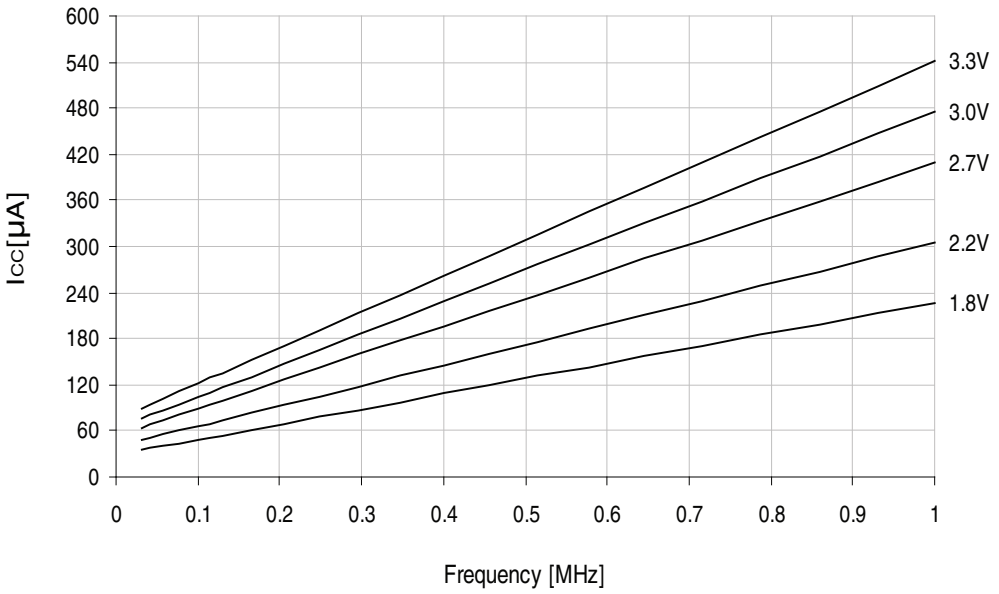


Figure 37-86.Active supply current vs. frequency.

f_{SYS} = 1 - 32MHz external clock, T = 25°C.

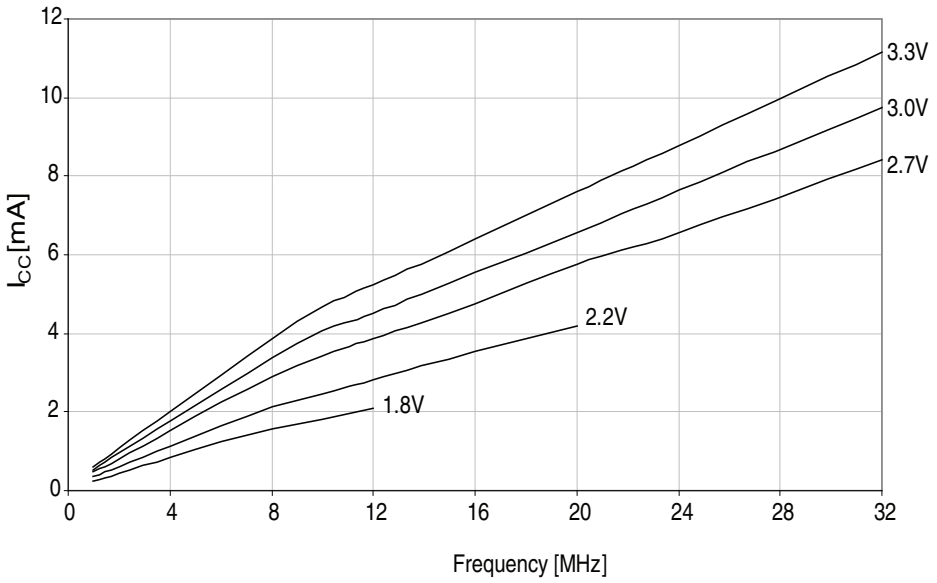


Figure 37-87.Active mode supply current vs. V_{CC}.

f_{SYS} = 32.768kHz internal oscillator.

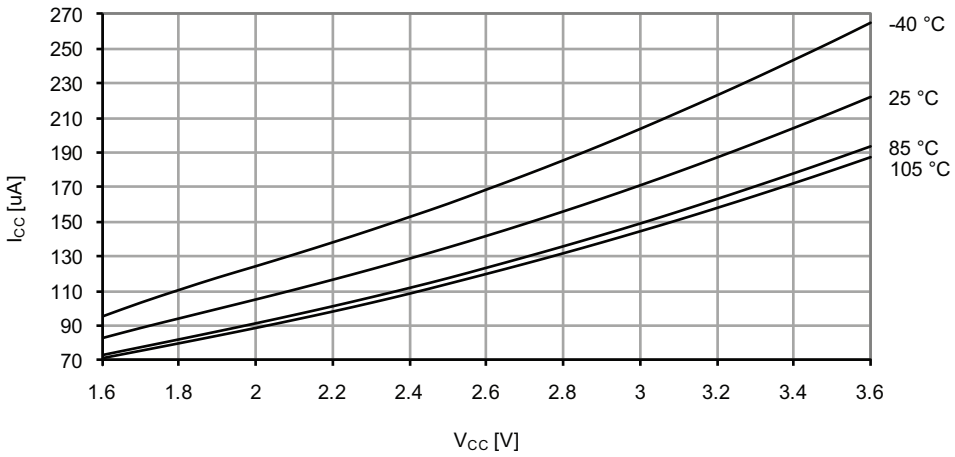


Figure 37-88.Active mode supply current vs. V_{CC}.

f_{SYS} = 1MHz external clock.

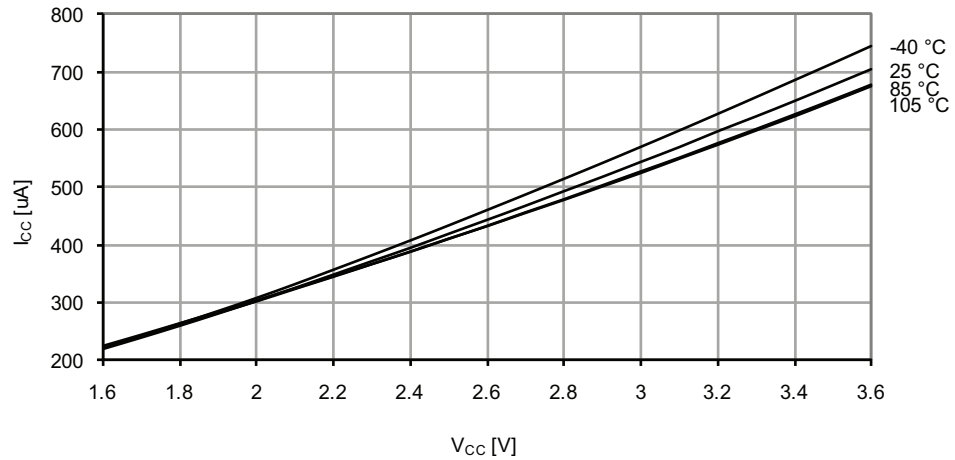


Figure 37-93.Idle mode supply current vs. frequency.

f_{SYS} = 1 - 32MHz external clock, T = 25°C.

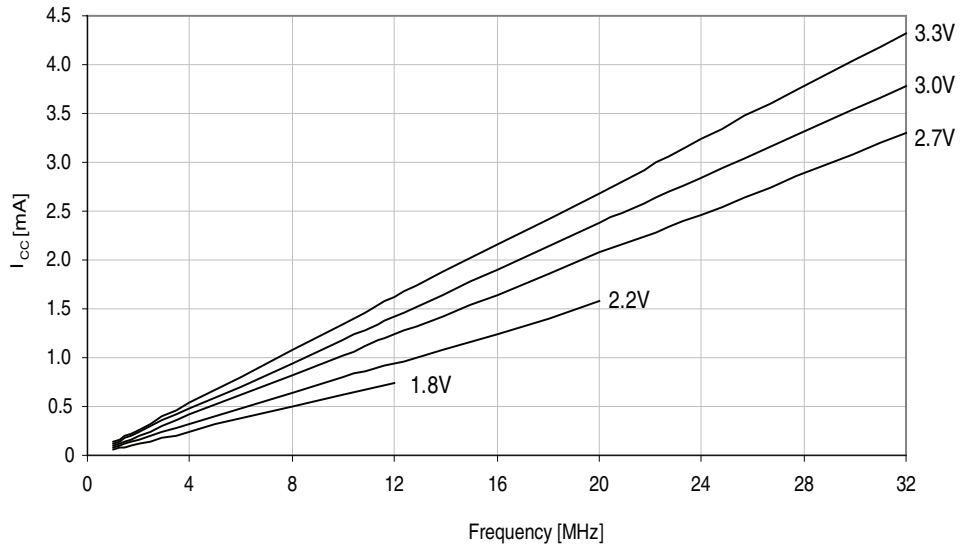
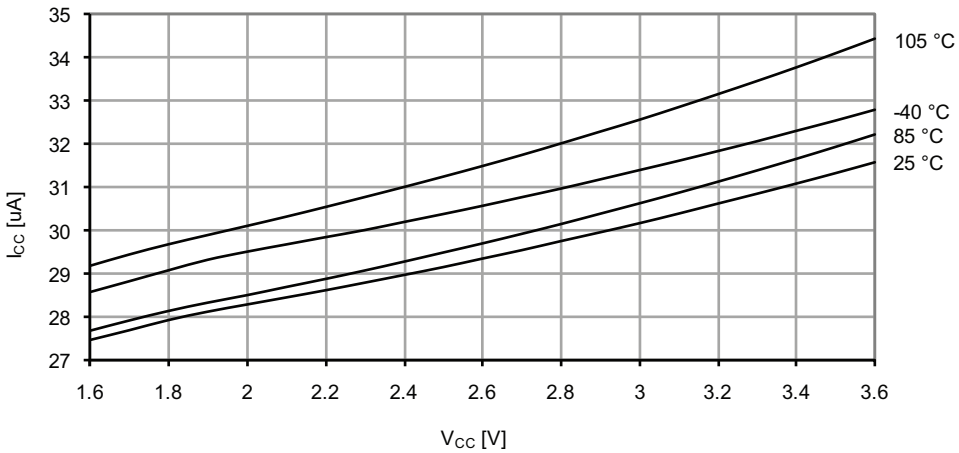


Figure 37-94. Idle mode supply current vs. V_{CC}.

f_{SYS} = 32.768kHz internal oscillator.



37.2.1.3 Power-down mode supply current

Figure 37-99. Power-down mode supply current vs. temperature.

All functions disabled.

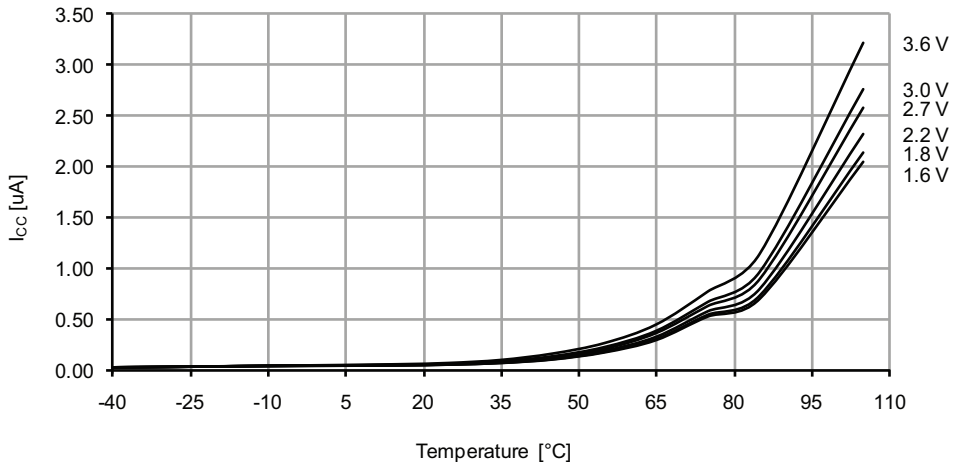


Figure 37-100. Power-down mode supply current vs. V_{CC}.

All functions disabled.

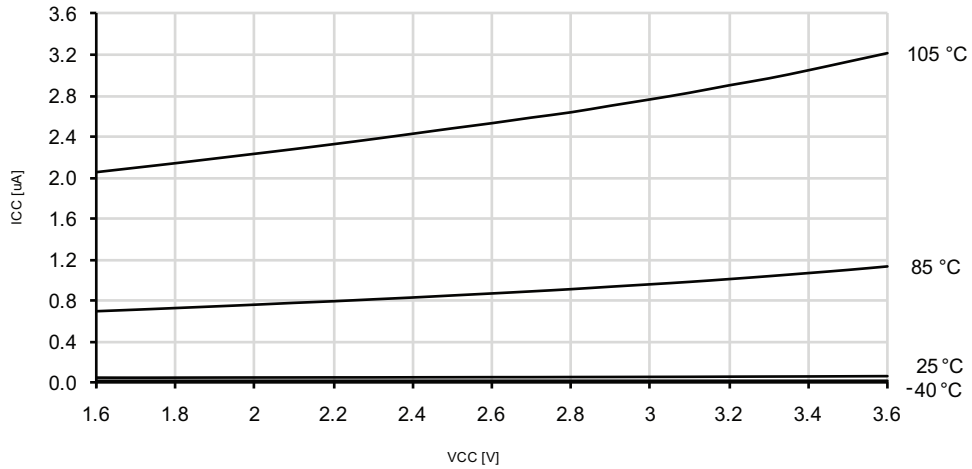


Figure 37-118. I/O pin input threshold voltage vs. V_{CC}.

V_{IL} I/O pin read as "0".

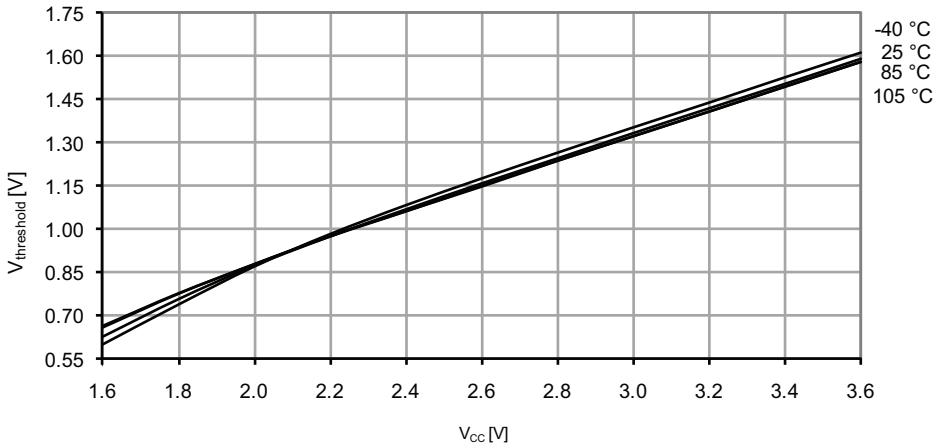


Figure 37-119. I/O pin input hysteresis vs. V_{CC}.

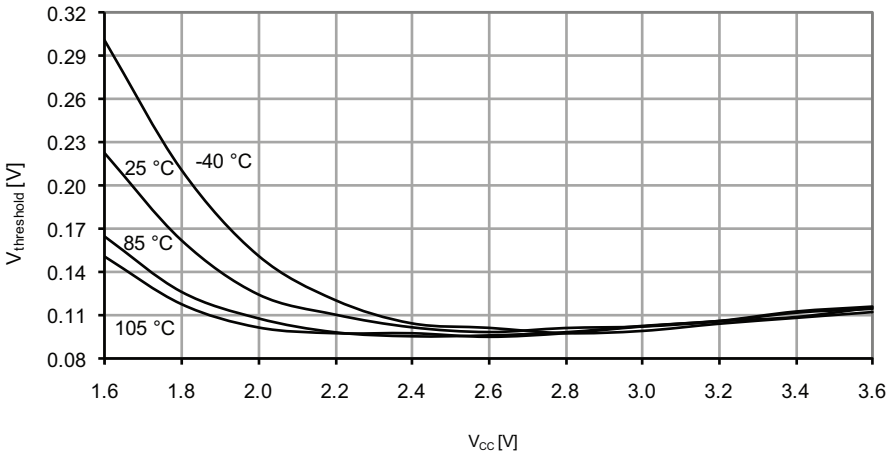


Figure 37-205. INL error vs. sample rate.

T = 25°C, V_{CC} = 2.7V, V_{REF} = 1.0V external.

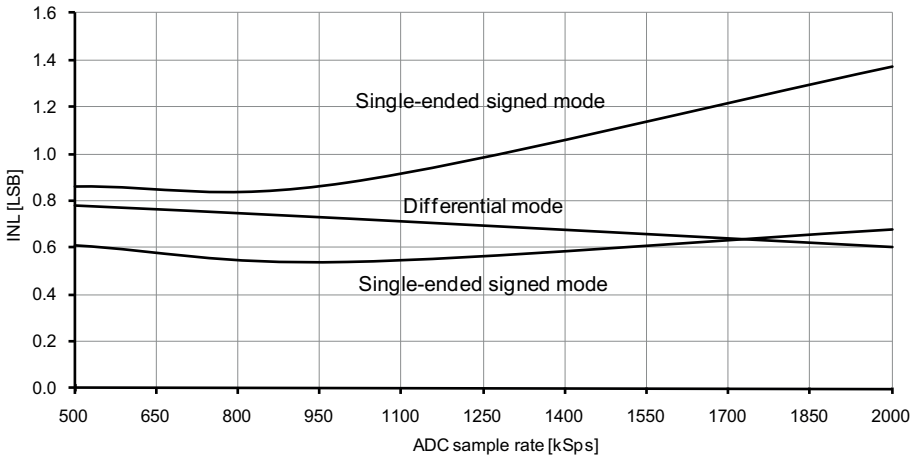
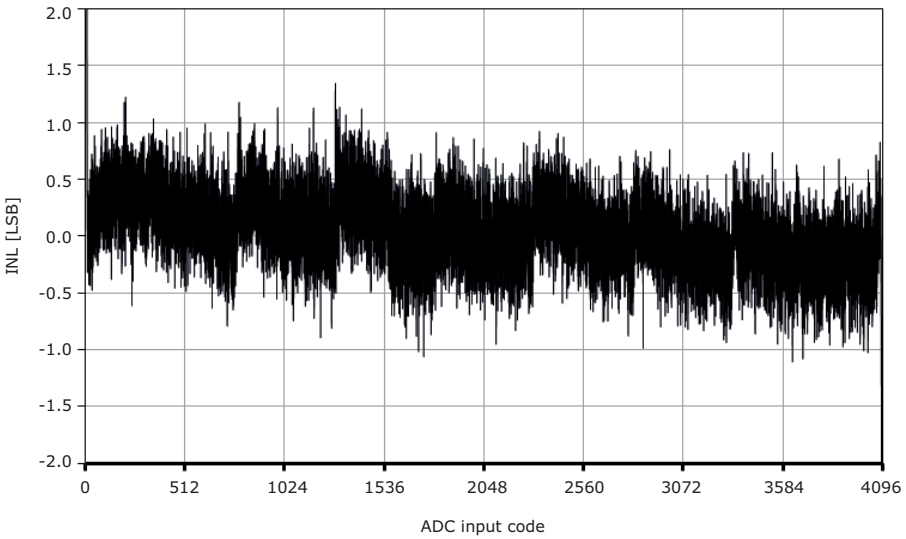


Figure 37-206. INL error vs. input code



37.3.10.2 32.768kHz Internal Oscillator

Figure 37-239. 32.768kHz internal oscillator frequency vs. temperature.

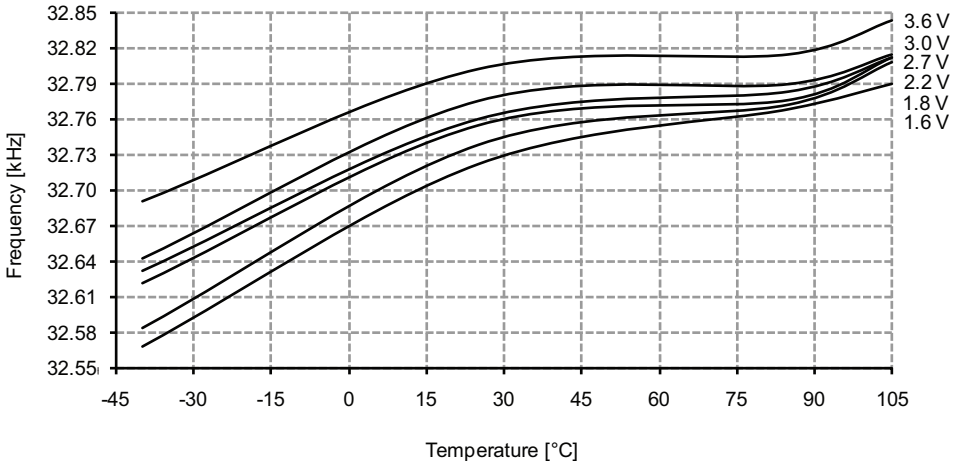


Figure 37-240. 32.768kHz internal oscillator frequency vs. calibration value.

V_{CC} = 3.0V, T = 25°C.

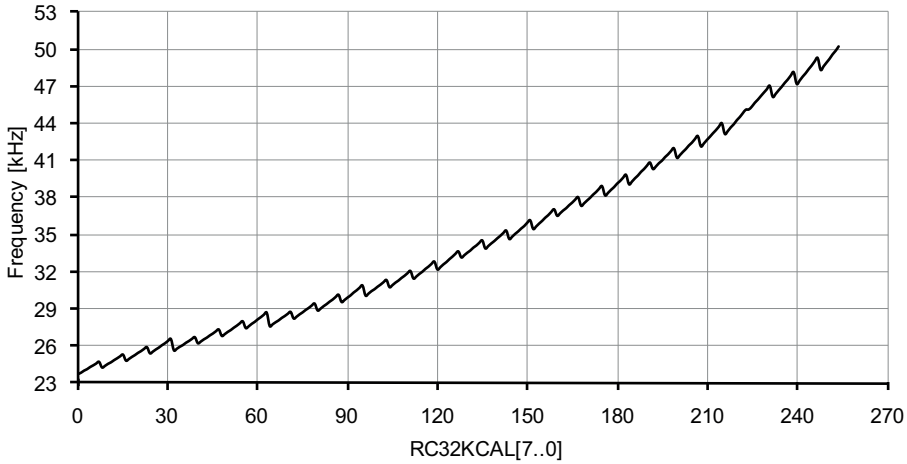


Figure 37-265. Idle mode supply current vs. V_{CC}.

f_{SYS} = 32MHz internal oscillator prescaled to 8MHz

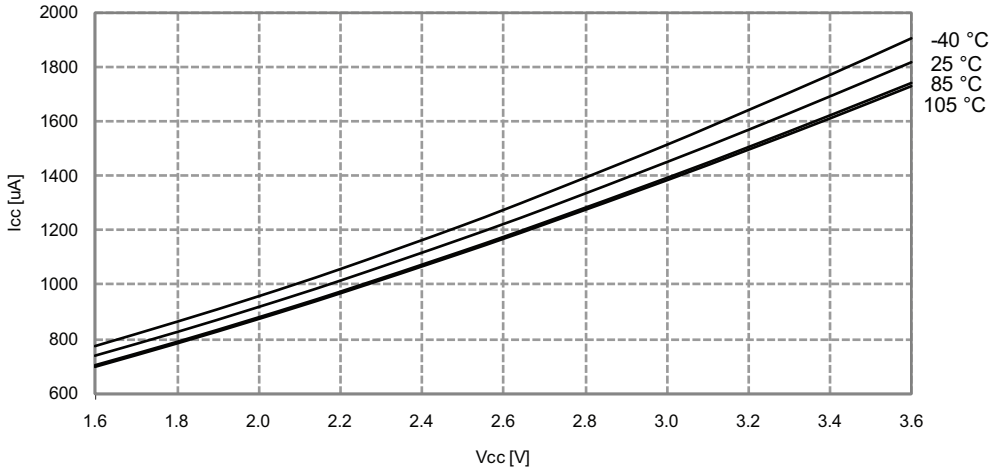
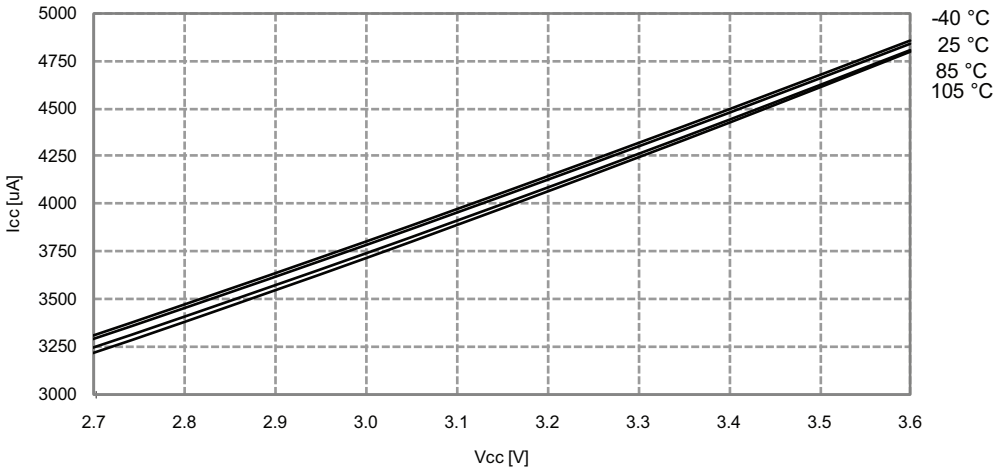


Figure 37-266. Idle mode current vs. V_{CC}.

f_{SYS} = 32MHz internal oscillator



37.4.1.3 Power-down mode supply current

Figure 37-267. Power-down mode supply current vs. temperature.

All functions disabled

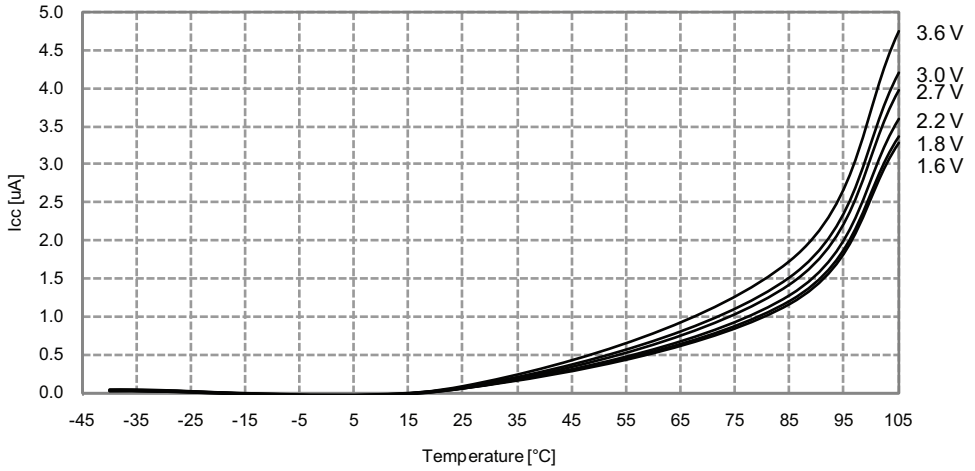
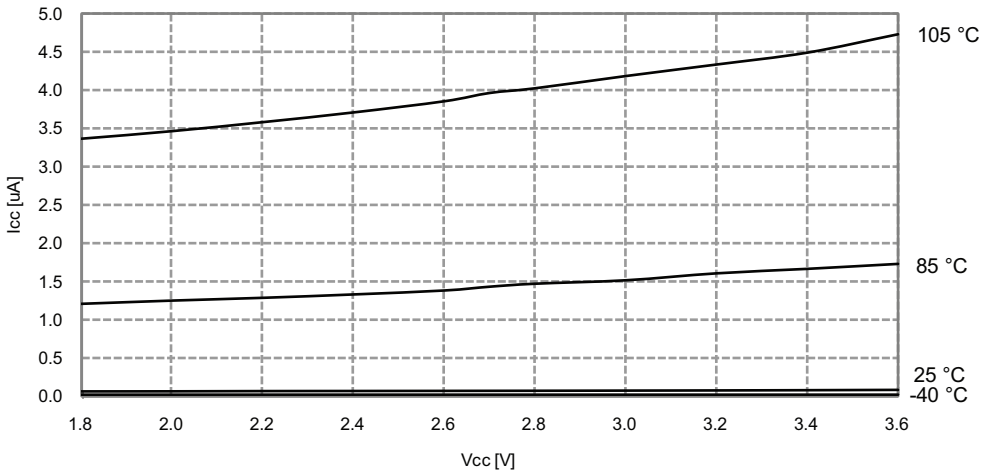


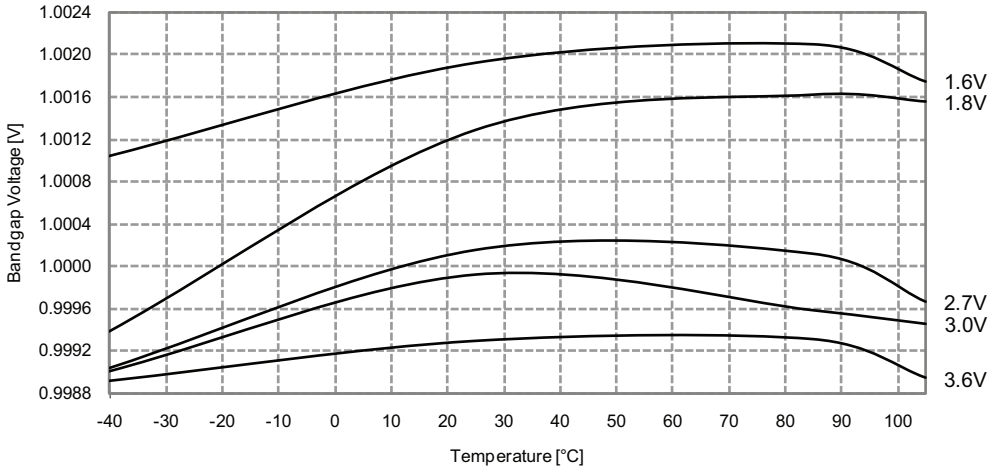
Figure 37-268. Power-down mode supply current vs. V_{CC}.

All functions disabled



37.4.6 Internal 1.0V reference Characteristics

Figure 37-311. ADC/DAC Internal 1.0V reference vs. temperature



37.4.7 BOD Characteristics

Figure 37-312. BOD thresholds vs. temperature.

BOD level = 1.6V